

KESTER ORGANIC WATER-SOLUBLE FLUX FORMULA NO. 2331ZX

No. 2331 is the standard organic flux for a variety of automated circuit board soldering applications. This latest development in organic fluxes is not a self-neutralizing flux but rather a truly neutral formulation. It cannot attack metal of epoxy-glass surfaces as experienced with the acid type organic fluxes. The residue can be removed completely with plain water without neutralizers. This biodegradable, non-acid flux is designed for modern wave or drag soldering machines. The formula contains no water, polyglycols or non-water-soluble solvent, is non-spattering and environmentally safe.

Cat. No.	Litres	Net Price
63-0097-2331	4.0	\$47.85

THINNER FORMULA 4662

For thinning 2331ZX Neutral Organic Flux, 2223 and 2235 Organic water-soluble fluxes.

Cat. No.	Litres	Net Price
63-0000-4662	4	\$42.17

KESTER 958 LOW SOLIDS NO-CLEAN SOLDERING FLUXES

No. 958 no-clean 2.7% solids; non-corrosive halogen free flux designed for wave soldering of conventional surface mount circuit board assemblies. Provides excellent soldering performance on bare copper printed circuit boards. Designed for both foam and spray flux applications. Use 4662SM Thinner to replace evaporated solvents and maintain flux activity.

Cat. No.	Litres	Net Price
63-0000-0958	4	\$42.17
64-0000-0958	20	189.60
65-0000-0958	200	1752.00

KESTER 959 LOW SOLIDS NO-CLEAN SOLDERING FLUXES

No. 959 no-clean 3.9% solids; non-corrosive, halogen free flux designed for wave soldering of conventional, and Surface Mount Board assemblies. Kester's 959 minimizes the formation of micro solder balls during wave soldering. Designed for both spray and foam flux application. Use 4662 SM Thinner to replace evaporated solvents and maintain flux activity.

Cat. No.	Litres	Net Price
63-0000-0959	4	\$42.17
64-0000-0959	20	178.13
65-0000-0959	200	1597.33

THINNER FORMULA 4662SM

For thinning 920 Halogen-Free Organic Flux, 958 and 959 Low Solids No-Clean Fluxes.

Cat. No.	Litres	Net Price
63-0024-4662	4	\$32.34

KESTER "979" VOC-FREE NO-CLEAN FLUXES

Developed to reduce bottomside micro-solder balling and bridging on glossy laminates and between connector pins. Designed as a spray flux, 979's activation system provides excellent wetting producing complete and consistent hole-fill. Compliant specifications: Bellcore Issue 1 GR-78 Core and ANSI/J-STD-004 Flux designator ORLO. Residue removal with hot de-ionized water at 140-160°F.

Cat. No.	Litres	Net Price
63-0000-0979	4	\$37.42
64-0000-0979	20	166.93
65-0000-0979	200	1634.29



KESTER LOW SOLIDS, NO CLEAN SM FLUX FORMULA NO. 951

Kester #951 is a halogen-free, non-rosin organic flux designed for wave soldering conventional and surface mount circuit board assemblies. The extremely low solids content (2.0%) and nature of the activator system results in practically NO RESIDUE left on the assembly after soldering. Boards are dry and cosmetically clean as they exit the wave solder machine. There are no residues to interfere with electrical testing and the expense of cleaning is eliminated. This non-corrosive and non-conductive flux meets the strict requirements of Bellcore GR-78 specification. This flux is suitable for automotive, computer, telecommunications and other applications.

Cat. No.	Litres	Net Price
63-0000-0951	4	\$40.91

KESTER REWORK FLUXES

Kester's two rework formulas are specifically formulated for PCB rework operations. Kester's RF741 No-Clean and RF-770 Water-Soluble rework fluxes will handle any surface mount or through-hole rework. Available only in syringe packaging.

Cat. No.	Description	Packaging	Net Price
57-0000-5053	RF-741 no-clean	10g syringe	\$8.43
57-0000-5025	RF-741 no-clean	30g syringe	24.00
57-0000-4153	RF-770 water soluble	10g syringe	8.43
57-0000-4125	RF-770 water soluble	30g syringe	24.00



KESTER BIO-KLEEN® FLUX RESIDUE CLEANER FORMULA NO. 5768

No. 5768 BiO-Kleen® is a highly-concentrated liquid cleaner used for the safe removal of rosin flux residues. The chemicals in the cleaner react with the rosin residues to form soaps which can then be rinsed away with water. Formula No. 5768 is designed for difficult to remove solder paste residues and is non reactive with most metals present on electronic assemblies.

Cat. No.	Litres	Net Price
63-0000-5768	4	\$91.94
64-0000-5768	20	247.47
65-0000-5768	200 Litre Drum	1760.00

THINNER FORMULA 110

For thinning #951 SM Flux.

Cat. No.	Litres	Net Price
63-0000-0110	4	\$35.89